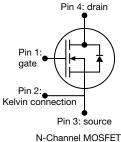
**Vishay Siliconix** 



# **E Series Power MOSFET**





PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.085			
Q <sub>g</sub> max. (nC)	53				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	13				
Configuration	Single				

### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 8 x 8			
Lead (Pb)-free and halogen-free	SiHH100N60E-T1-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			LIMIT	UNIT		
Drain-source voltage			600	v		
Gate-source voltage			± 30	v		
Continuous drain current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 2$ $T_C = 10$	5°C	28			
	$V_{GS}$ at 10 V $T_C = 10$	<sup>D</sup> °C	18	А		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	63				
Linear derating factor			1.38	W/°C		
Single pulse avalanche energy <sup>b</sup>			127	mJ		
Maximum power dissipation			174	W		
Operating junction and storage temperature ra	ange	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 12	25 °C	100	V/ns		
Reverse diode dv/dt <sup>c</sup>			50	V/115		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.0 A
- c.  $I_{SD} \leq I_D, \, di/dt$  = 120 A/µs, starting  $T_J$  = 25  $^\circ C$



COMPLIANT

HALOGEN

FREE



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	40	42	°C ///		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	0.55	0.72	°C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-		-			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.55	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	3.0	-	5.0	V
		,	$V_{GS} = \pm 20 V$		-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
Zere gete veltage drein ourrent	1	V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	∕, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 13.5 A	-	0.085	0.100	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 8 V, I <sub>D</sub> = 13.5 A	-	12	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	1850	-	
Output capacitance	C <sub>oss</sub>		$V_{\rm DS} = 100  \rm V,$	-	83	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		6	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$			-	64	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		410	-	
Total gate charge	Qg			-	35	53	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 13.5 A, V <sub>DS</sub> = 480 V		11	-	nC
Gate-drain charge	Q <sub>gd</sub>	1 [		-	13	-	
Turn-on delay time	t <sub>d(on)</sub>		l l		26	52	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> = 13.5 A,	-	54	81	- ns
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> = 9.1 Ω	-	41	82	
Fall time	t <sub>f</sub>			-	41	82	
Gate input resistance	Rg	f = 1	f = 1 MHz, open drain		0.6	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	28	
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode		-	-	63	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 13.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				345	690	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 13.5 A, di/dt = 100 A/μs, V <sub>R</sub> = 25 V		-	5.0	10	μC
Reverse recovery current	I <sub>RRM</sub>			-	24	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

2



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

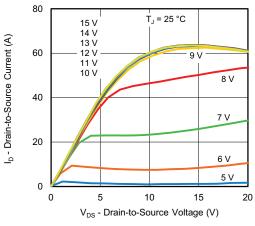


Fig. 1 - Typical Output Characteristics

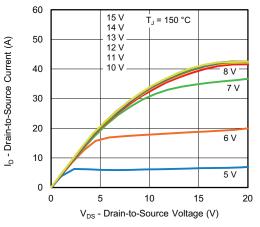


Fig. 2 - Typical Output Characteristics

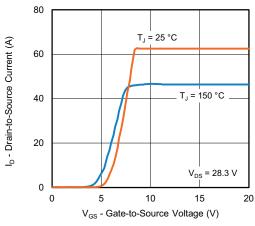


Fig. 3 - Typical Transfer Characteristics

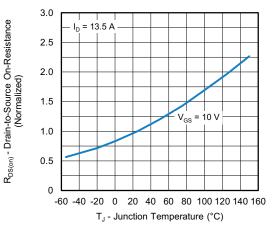


Fig. 4 - Normalized On-Resistance vs. Temperature

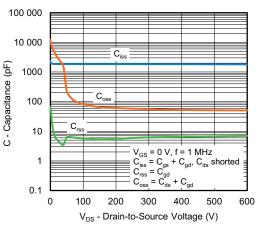


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

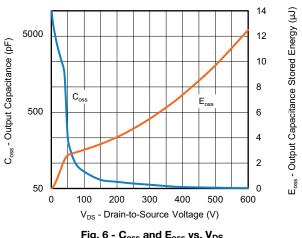


Fig. 6 - Coss and Eoss vs. VDS

S20-0341-Rev. C, 11-May-2020

3 For technical questions, contact: hvm@vishay.com Document Number: 92126

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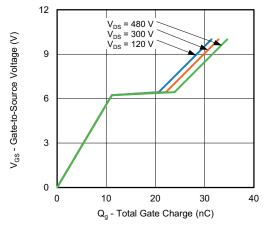


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

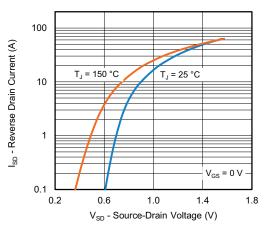


Fig. 8 - Typical Source-Drain Diode Forward Voltage

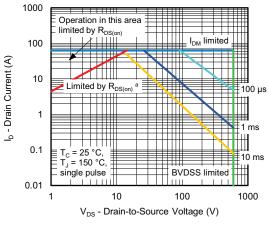


Fig. 9 - Maximum Safe Operating Area

Note

a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

4

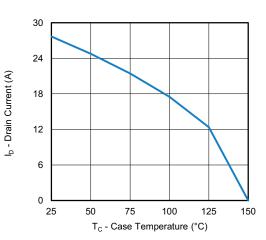


Fig. 10 - Maximum Drain Current vs. Case Temperature

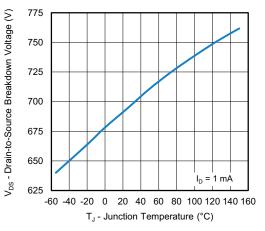
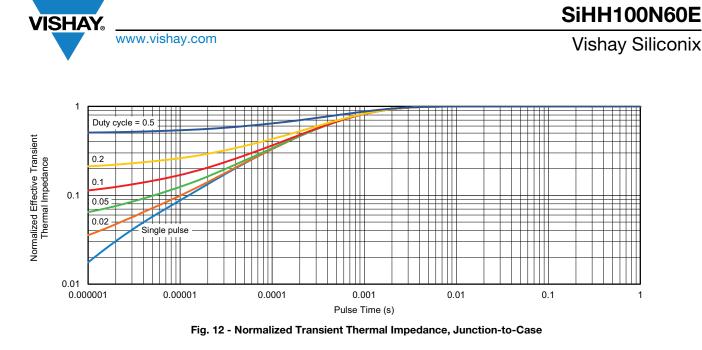


Fig. 11 - Temperature vs. Drain-to-Source Voltage



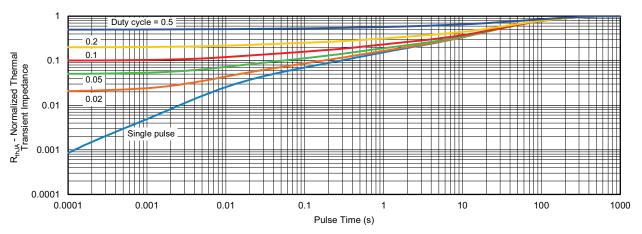


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

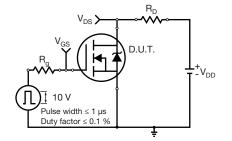


Fig. 14 - Switching Time Test Circuit

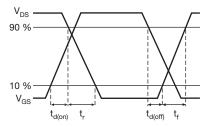


Fig. 15 - Switching Time Waveforms



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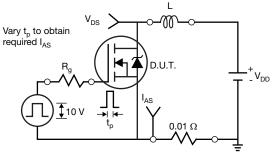


Fig. 16 - Unclamped Inductive Test Circuit

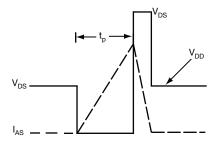


Fig. 17 - Unclamped Inductive Waveforms

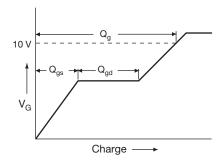


Fig. 18 - Basic Gate Charge Waveform

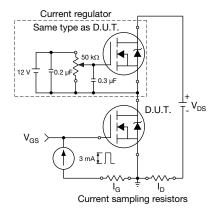
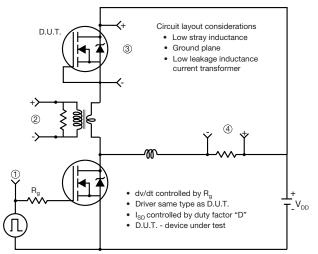


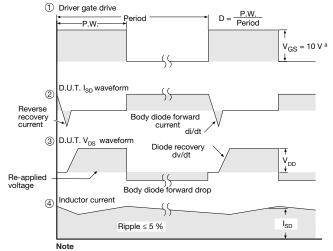
Fig. 19 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit





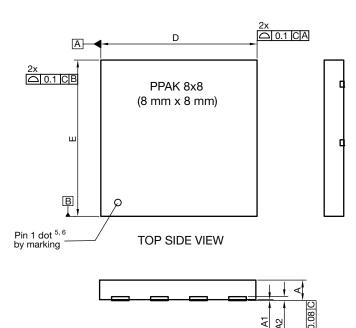
a.  $V_{GS} = 5$  V for logic level devices

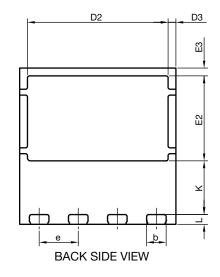
Fig. 20 - For N-Channel

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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES			
Dilvi.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A <sup>8</sup>	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.			0.008 ref.		
b <sup>4</sup>	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC			0.016 BSC		
e	2.00 BSC		0.079 BSC				
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3	0.40 BSC			0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>3</sup>	8				8		

D

#### Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5 M - 1994.

3. N is the number of terminals.

4. Package warpage max. 0.08 mm.

5. The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

ECN: T15-0225-Rev. A, 18-May-15 DWG: 6041

Revision: 18-May-15

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



Vishay

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